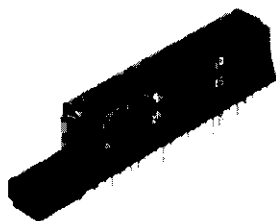


Sealed Connectors



Housing Material—Fer
MIL-C-55302 or MIL-M-24519 type
GLCP-30F

Contact Material and Finish—
Beryllium copper per QQ-C-553 plated
.000050 [.0012/.1] gold in the contact
area, .000100 [.00254] tin/lead on the
solder tails over .000030 [.00076]
nickel on the entire contact

Related Product Data:

Mates with—Pin Header Assemblies,
pages 52 thru 56

External Keying—page 79

Mating Sealed Pin Header

Assembly—Contact your AMP sales
engineer or call 1-800-522-6752

